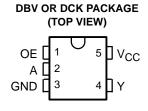
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- Operating Range of 4.5 V to 5.5 V
- Max t<sub>pd</sub> of 6 ns at 5 V
- Low Power Consumption, 10-μA Max I<sub>CC</sub>
- ±8-mA Output Drive at 5 V
- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



### description/ordering information

The SN74AHCT1G126 is a single bus buffer gate/line driver with 3-state output. The output is disabled when the output-enable (OE) input is low. When OE is high, true data is passed from the A input to the Y output.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

### ORDERING INFORMATION

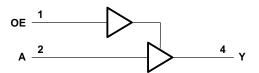
TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
	SOT (SOT-23) – DBV	Reel of 3000	SN74AHCT1G126DBVR	B26
4000 1- 0500	301 (301-23) – DBV	Reel of 250	SN74AHCT1G126DBVT	D20_
–40°C to 85°C		Reel of 3000	SN74AHCT1G126DCKR	DN
	SOT (SC-70) – DCK	Reel of 250	SN74AHCT1G126DCKT	BN_

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

### **FUNCTION TABLE**

INP	JTS	OUTPUT
OE	Α	Y
Н	Н	Н
Н	L	L
L	Χ	Z

### logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



<sup>‡</sup> The actual top-side marking has one additional character that designates the assembly/test site.

### SN74AHCT1G126 SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Output voltage range, VO (see Note 1)	0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through V <sub>CC</sub> or GND	±50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DBV package	206°C/W
DCK package	252°C/W
Storage temperature range, T <sub>stq</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
$V_{IL}$	Low-level input voltage		0.8	V
٧ <sub>I</sub>	Input voltage	0	5.5	V
٧o	Output voltage	0	VCC	V
ІОН	High-level output current		-8	mA
lOL	Low-level output current		8	mA
Δt/Δν	Input transition rise or fall rate		20	ns/V
T <sub>A</sub>	Operating free-air temperature	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
PARAWETER	TEST CONDITIONS	vcc	MIN	TYP	MAX		WAX	UNII
VOH	$I_{OH} = -50 \mu A$	4.5 V	4.4	4.5		4.4		V
VOH	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		
V	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1	<
VOL	$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44	
lį	V <sub>I</sub> = 5.5 V or GND	0 V to 5.5 V			±0.1		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.25		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
Δl <sub>CC</sub> ‡	One input at 3.4 V, Other input at V <sub>CC</sub> or GND	5.5 V			1.35		1.5	mA
C <sub>i</sub>	$V_I = V_{CC}$ or GND	5 V		4	10		10	pF
Co	$V_O = V_{CC}$ or GND	5 V		10				pF

<sup>‡</sup> This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or VCC.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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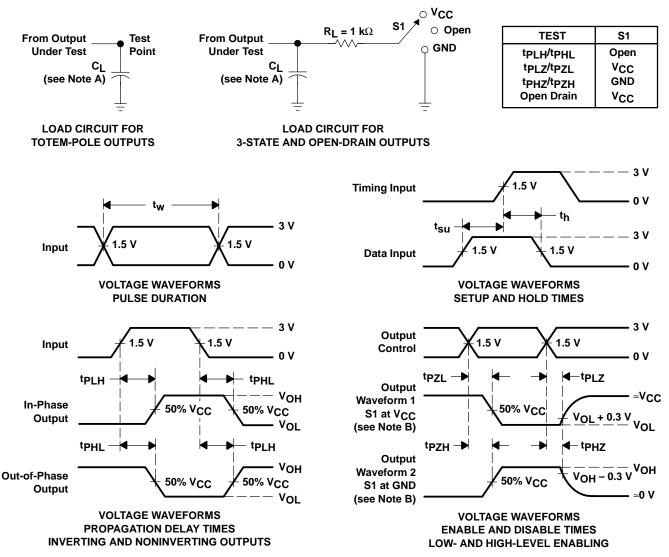
# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO LOAD	то	то	FROM TO LOAD	T	T <sub>A</sub> = 25°C		MIN MAX	MAV	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT		
<sup>t</sup> PLH	А	Y	C <sub>L</sub> = 15 pF		3.8	5.5	1	6.5	ns		
tPHL	^	!	OL = 13 pi		3.8	5.5	1	6.5	115		
<sup>t</sup> PZH	OE	Y	C: - 15 pE		3.6	5.1	1	6	ns		
<sup>t</sup> PZL	OE	T I	C <sub>L</sub> = 15 pF		3.6	5.1	1	6	115		
<sup>t</sup> PHZ	OE	Y	C <sub>L</sub> = 15 pF		4.6	6.8	1	8	no		
<sup>t</sup> PLZ			OL = 15 pr		4.6	6.8	1	8	ns		
t <sub>PLH</sub>	А	Y	C <sub>L</sub> = 50 pF		5.3	7.5	1	8.5	ns		
<sup>t</sup> PHL	A		OL = 30 pr		5.3	7.5	1	8.5	115		
<sup>t</sup> PZH	OE	Y	C: _ 50 pF		5.1	7.1	1	8	no		
<sup>t</sup> PZL	OE	r	C <sub>L</sub> = 50 pF		5.1	7.1	1	8	ns		
<sup>t</sup> PHZ	OE	Y C <sub>L</sub> = 50	C: = 50 pE		6.1	8.8	1	10	ns		
tPLZ	]		Ť	OL = 50 PF		6.1	8.8	1	10	115	

## operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER		TEST C	ONDITIONS	TYP	UNIT
Г	C <sub>pd</sub>	Power dissipation capacitance	No load,	f = 1 MHz	14	pF

### PARAMETER MEASUREMENT INFORMATION



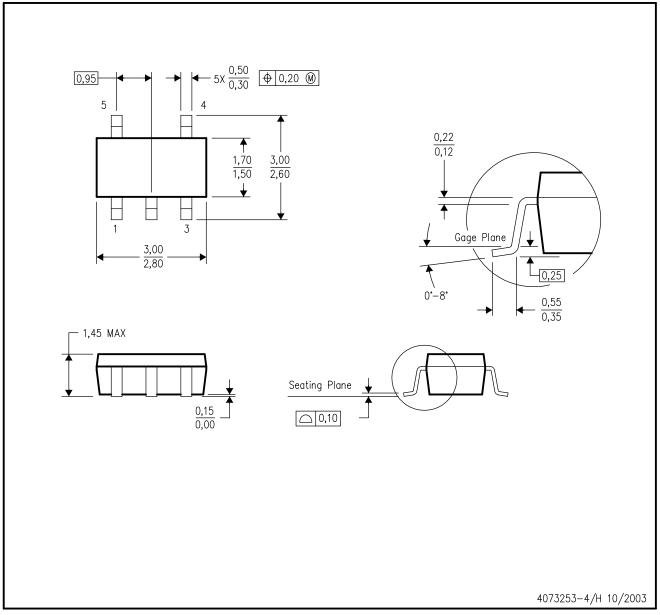
- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 3$  ns.  $t_f \leq 3$  ns.
  - D. The outputs are measured one at a time with one input transition per measurement.
  - E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



# DBV (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE



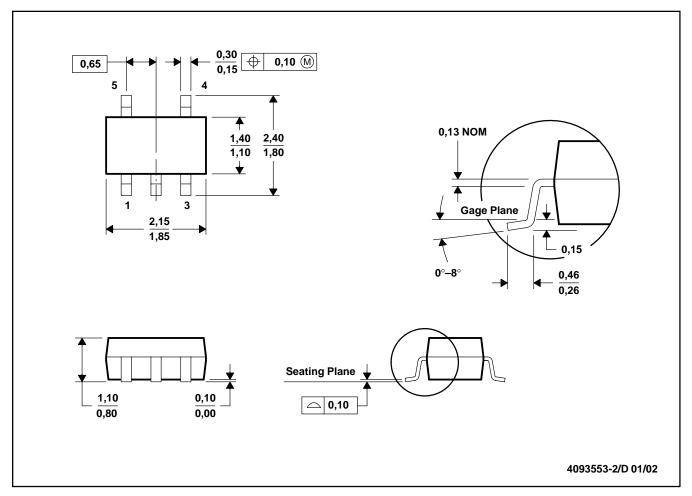
NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



## DCK (R-PDSO-G5)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC MO-203

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